



A Product Line of **Diodes Incorporated**



ZVN4106F

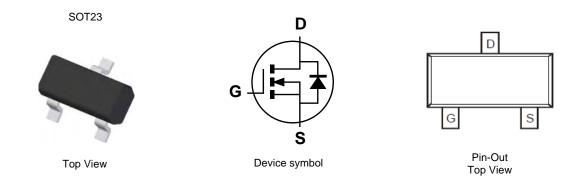
60V N-CHANNEL ENHANCEMENT MODE VERTICAL DMOSFET IN SOT23

Features

- $BV_{DSS} > 60V$ •
- $R_{DS(on)} \le 2.5\Omega @ V_{GS} = 10V$
- Maximum continuous drain current I_D = 200mA
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SOT23 •
- Case Material: Molded Plastic, "Green" Molding Compound. UL • Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish. Solderable per MIL-STD-202, Method 208 **@3**
- Weight: 0.008 grams (approximate)



Ordering Information (Note 4)

Part Number	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
ZVN4106FTA	MZ	7	8	3000

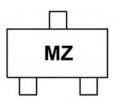
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. Notes:

2. See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com.

Marking Information



MZ = Product Type Marking Code





Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Drain-Source Voltage	V _{DSS}	60	V
Gate-Source Voltage	V _{GSS}	±20	V
Continuous Drain Current	ID	200	mA
Pulsed Drain Current (Note 5)	I _{DM}	3	A

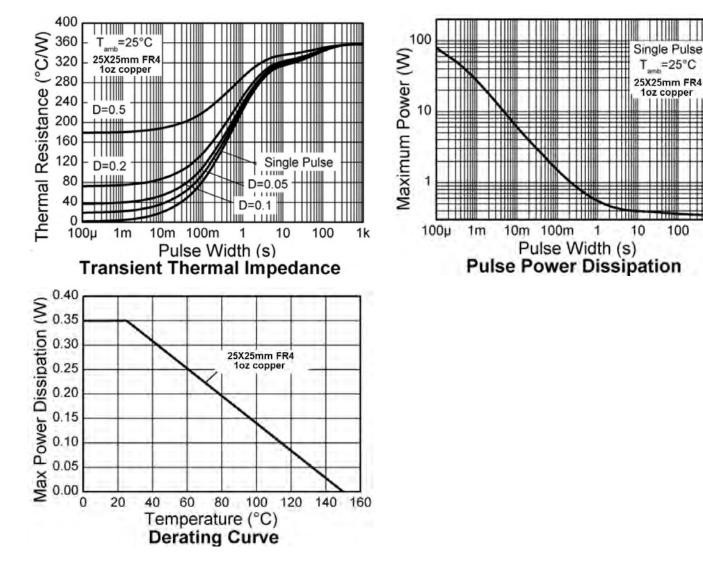
Thermal Characteristics

Characteristic	Symbol	Value	Unit	
Power Dissipation	(Note 6)	PD	350	mW
Thermal Resistance, Junction to Ambient (Note 6)		R _{0JA}	357	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	С°	

Notes: 5. Device mounted on minimum recommended pad layout test board, 10 s pulse duty cycle = 1%.

6. For a device mounted on 25mm X 25mm X 1.6mm FR-4 PCV with high coverage of single sided 1oz copper, in still air condition.

Thermal Characteristics



1k





Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

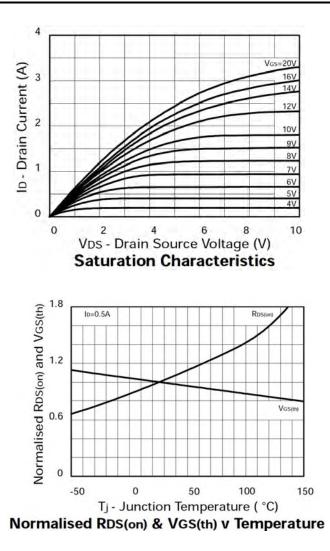
Characteristic	Symbol	Min	Тур	Мах	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	60	_	—	V	$V_{GS} = 0V, I_{D} = 10mA$	
Zero Gate Voltage Drain Current TJ = +25°C	IDSS	_	-	10 50	μA	V _{DS} = 60V, V _{GS} = 0V V _{DS} = 48V, V _{GS} = 0V, T _A = +125°C	
Gate-Source Leakage	I _{GSS}	_	_	100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
On-State Drain Current	I _{D(on)}	1	—	-	Α	V _{GS} = 10V, V _{DS} = 15V	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(th)}	1.3	—	3	V	$V_{DS} = V_{GS}$, $I_D = 1mA$	
Static Drain-Source On-Resistance	R _{DS (on)}		_	2.5 5	Ω	V _{GS} = 10V, I _D = 500mA V _{GS} = 5V, I _D = 200mA	
Forward Transconductance		150	_	-	mS	$V_{DS} = 25V, I_D = 250mA$	
DYNAMIC CHARACTERISTICS (Note 7)						•	
Input Capacitance	Ciss	_	—	35	pF		
Output Capacitance	C _{oss}	—	—	25	pF	V _{DS} = 25V, V _{GS} = 0V, f = 1.0MHz	
Reverse Transfer Capacitance	C _{rss}	_	—	8	pF		
Turn-On Delay Time	t _{D(on)}	_	—	5	ns		
Turn-On Rise Time	tr	—	—	7	ns		
Turn-Off Delay Time	t _{D(off)}	—	—	6	ns	V _{DS} = 25V, I _D = 150mA	
Turn-Off Fall Time	t _f	—	_	8	ns		

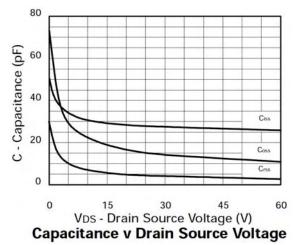
Notes: 7. Short duration pulse test used to minimize self-heating effect.

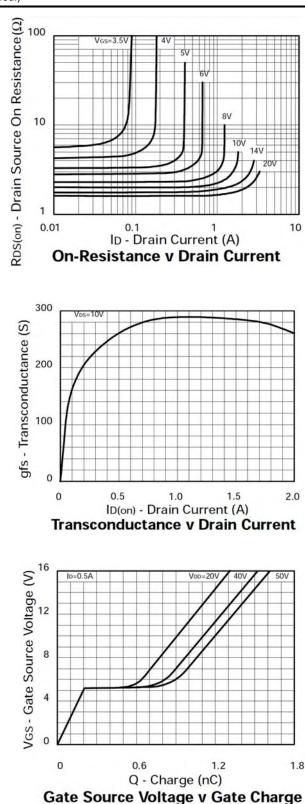




Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)



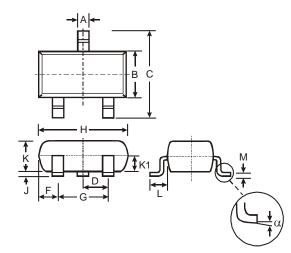






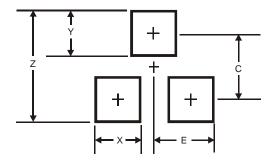


Package Outline Dimensions



SOT23					
Dim	Min	Max	Тур		
Α	0.37	0.51	0.40		
В	1.20	1.40	1.30		
С	2.30	2.50	2.40		
D	0.89	1.03	0.915		
F	0.45	0.60	0.535		
G	1.78	2.05	1.83		
H	2.80	3.00	2.90		
J	0.013	0.10	0.05		
К	0.903	1.10	1.00		
K1	-	-	0.400		
L	0.45	0.61	0.55		
М	0.085	0.18	0.11		
α	0°	8°	-		
All Dimensions in mm					

Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.9
Х	0.8
Y	0.9
С	2.0
E	1.35





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